

# 2N7002L

## Small Signal MOSFET

60 V, 115 mA, N-Channel SOT-23

### Features

- Pb-Free Packages are Available

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	60	Vdc
Drain-Gate Voltage ( $R_{GS} = 1.0 \text{ M}\Omega$ )	$V_{DGR}$	60	Vdc
Drain Current – Continuous $T_C = 25^\circ\text{C}$ (Note 1) $T_C = 100^\circ\text{C}$ (Note 1) – Pulsed (Note 2)	$I_D$ $I_D$ $I_{DM}$	$\pm 115$ $\pm 75$ $\pm 800$	mAdc
Gate-Source Voltage – Continuous – Non-repetitive ( $t_p \leq 50 \mu\text{s}$ )	$V_{GS}$ $V_{GSM}$	$\pm 20$ $\pm 40$	Vdc Vpk

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 3) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	225 1.8	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	$^\circ\text{C}/\text{W}$
Total Device Dissipation Alumina Substrate, (Note 4) $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	300 2.4	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

1. The Power Dissipation of the package may result in a lower continuous drain current.
2. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .
3. FR-5 =  $1.0 \times 0.75 \times 0.062$  in.
4. Alumina =  $0.4 \times 0.3 \times 0.025$  in 99.5% alumina.

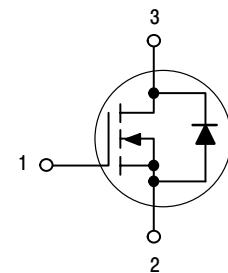


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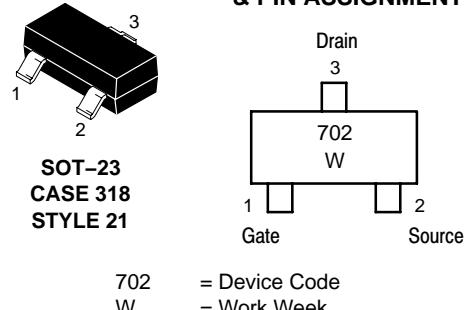
<http://onsemi.com>

$V_{(BR)DSS}$	$R_{DS(on)}$ MAX	$I_D$ MAX
60 V	$7.5 \Omega @ 10 \text{ V},$ 500 mA	115 mA

### N-Channel



### MARKING DIAGRAM & PIN ASSIGNMENT



### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
2N7002LT1	SOT-23	3000 Tape & Reel
2N7002LT3		10,000 Tape & Reel
2N7002LT1G	SOT-23 (Pb-free)	3000 Tape & Reel
2N7002LT3G		10,000 Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# 2N7002L

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Drain-Source Breakdown Voltage ( $V_{GS} = 0$ , $I_D = 10 \mu\text{A}$ )	$V_{(BR)DSS}$	60	—	—	Vdc
Zero Gate Voltage Drain Current ( $V_{GS} = 0$ , $V_{DS} = 60 \text{ Vdc}$ )	$I_{DSS}$	— —	— —	1.0 500	$\mu\text{A}$
Gate-Body Leakage Current, Forward ( $V_{GS} = 20 \text{ Vdc}$ )	$I_{GSSF}$	—	—	100	nA
Gate-Body Leakage Current, Reverse ( $V_{GS} = -20 \text{ Vdc}$ )	$I_{GSSR}$	—	—	-100	nA

## ON CHARACTERISTICS (Note 5)

Gate Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$ )	$V_{GS(\text{th})}$	1.0	—	2.5	Vdc
On-State Drain Current ( $V_{DS} \geq 2.0 \text{ V}_{DS(\text{on})}$ , $V_{GS} = 10 \text{ Vdc}$ )	$I_{D(\text{on})}$	500	—	—	mA
Static Drain-Source On-State Voltage ( $V_{GS} = 10 \text{ Vdc}$ , $I_D = 500 \text{ mA}$ ) ( $V_{GS} = 5.0 \text{ Vdc}$ , $I_D = 50 \text{ mA}$ )	$V_{DS(\text{on})}$	— —	— —	3.75 0.375	Vdc
Static Drain-Source On-State Resistance ( $V_{GS} = 10 \text{ V}$ , $I_D = 500 \text{ mA}$ ) ( $V_{GS} = 5.0 \text{ Vdc}$ , $I_D = 50 \text{ mA}$ )	$r_{DS(\text{on})}$	— — — —	— — — —	7.5 13.5 7.5 13.5	Ohms
Forward Transconductance ( $V_{DS} \geq 2.0 \text{ V}_{DS(\text{on})}$ , $I_D = 200 \text{ mA}$ )	$g_{FS}$	80	—	—	mmhos

## DYNAMIC CHARACTERISTICS

Input Capacitance ( $V_{DS} = 25 \text{ Vdc}$ , $V_{GS} = 0$ , $f = 1.0 \text{ MHz}$ )	$C_{iss}$	—	—	50	pF
Output Capacitance ( $V_{DS} = 25 \text{ Vdc}$ , $V_{GS} = 0$ , $f = 1.0 \text{ MHz}$ )	$C_{oss}$	—	—	25	pF
Reverse Transfer Capacitance ( $V_{DS} = 25 \text{ Vdc}$ , $V_{GS} = 0$ , $f = 1.0 \text{ MHz}$ )	$C_{rss}$	—	—	5.0	pF

## SWITCHING CHARACTERISTICS (Note 5)

Turn-On Delay Time	$(V_{DD} = 25 \text{ Vdc}, I_D \leq 500 \text{ mA}, R_G = 25 \Omega, R_L = 50 \Omega, V_{gen} = 10 \text{ V})$	$t_{d(\text{on})}$	—	—	20	ns
Turn-Off Delay Time		$t_{d(\text{off})}$	—	—	40	ns

## BODY-DRAIN DIODE RATINGS

Diode Forward On-Voltage ( $I_S = 11.5 \text{ mA}$ , $V_{GS} = 0 \text{ V}$ )	$V_{SD}$	—	—	-1.5	Vdc
Source Current Continuous (Body Diode)	$I_S$	—	—	-115	mA
Source Current Pulsed	$I_{SM}$	—	—	-800	mA

5. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

## TYPICAL ELECTRICAL CHARACTERISTICS

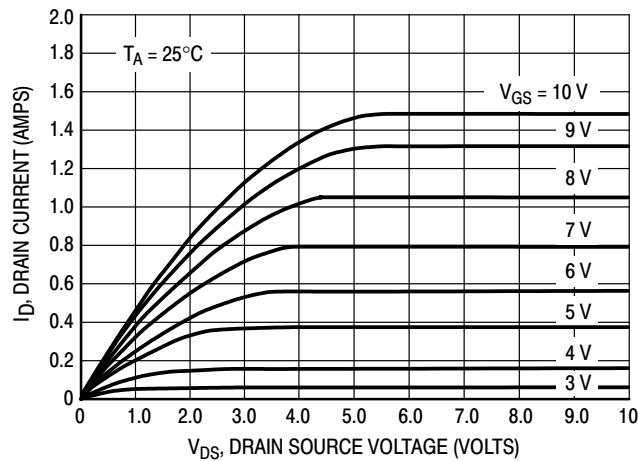


Figure 1. Ohmic Region

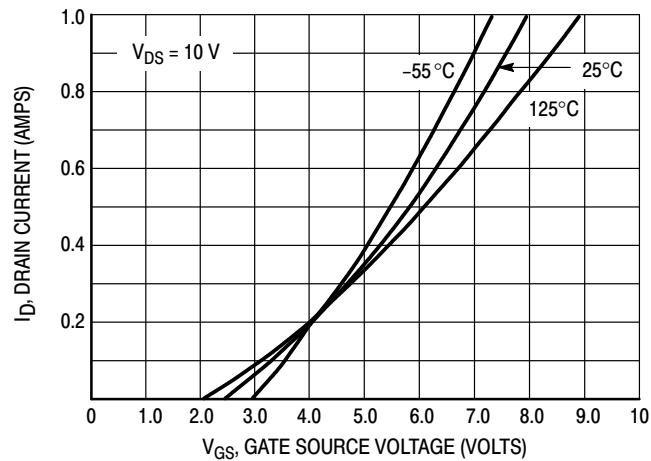


Figure 2. Transfer Characteristics

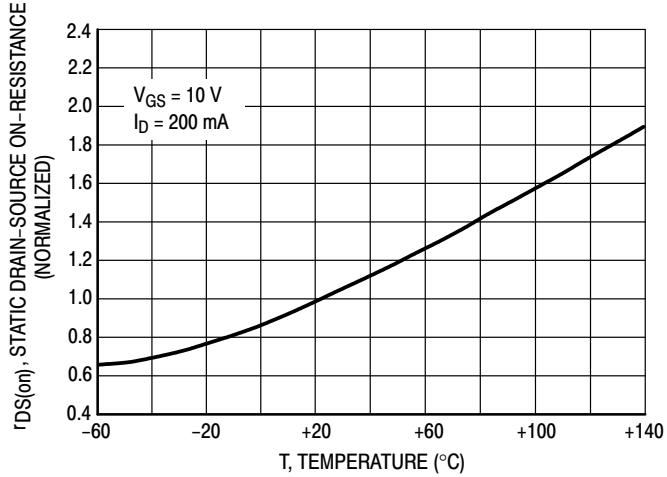


Figure 3. Temperature versus Static Drain-Source On-Resistance

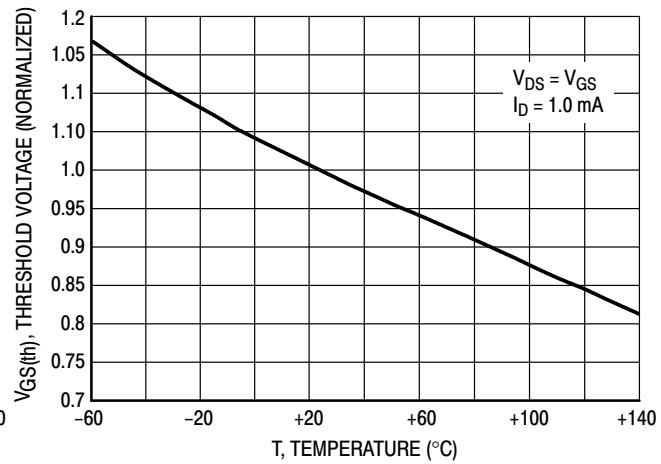


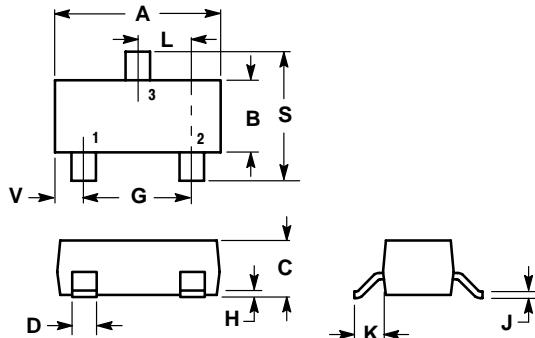
Figure 4. Temperature versus Gate Threshold Voltage

## PACKAGE DIMENSIONS

## SOT-23 (TO-236)

CASE 318-08

ISSUE AH



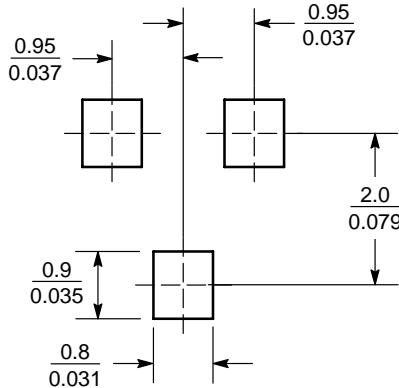
## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 318-03 AND -07 OBSOLETE, NEW STANDARD 318-08.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

STYLE 21:  
 PIN 1. GATE  
 2. SOURCE  
 3. DRAIN

## SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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